

N-Channel Reduced Q_g , Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
30	0.007 at V _{GS} = 10 V	16	11		
	0.0095 at V _{GS} = 4.5 V	13.5			

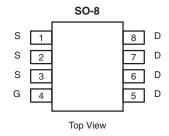
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Gen II Power MOSFETs
- · PWM Optimized
- 100 % R_g Tested

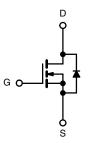


APPLICATIONS

• DC/DC Conversion for PC



Ordering Information: Si4386DY-T1-E3 (Lead (Pb)-free) Si4386DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS TA	$_{\lambda}$ = 25 °C, unle	ss otherwise r	noted			
Parameter	Symbol	10 s	Steady State	Unit		
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 20			
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	16	11		
Continuous Dialit Current (1) = 150 C)	T _A = 70 °C		13	9		
Pulsed Drain Current		I _{DM}	± 50		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	2.8	1.3		
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	20			
Avalanche Energy	L = 0.111111	E _{AS}	20		mJ	
Manianum Danian Disaination	T _A = 25 °C	P _D	3.1	1.47	W	
Maximum Power Dissipation ^a	T _A = 70 °C	۵' ا	2	0.95	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 5	5 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manipular Institut to Applicant (MOCFET)	t ≤ 10 s	R _{thJA}	34	40		
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State	' 'thJA	71	85	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	18	22		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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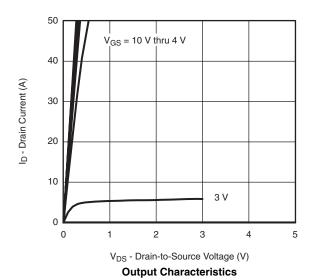
MOSFET SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ 1.5		2.0	2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Coto Voltago Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
		$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$		0.0058	0.007	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 13.5 \text{ A}$		0.0078	0.0095	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 16 A		51		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b			<u>'</u>	•		I.	
Total Gate Charge	Q_g			11	18		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 16 \text{ A}$		5.8		nC	
Gate-Drain Charge	Q_{gd}			3.0			
Gate Resistance	R_{g}		0.8	1.7	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			12	18		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		9	14		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		35	53	ns	
Fall Time	t _f			10	15		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, dI/dt = 100 A/μs		25	50		

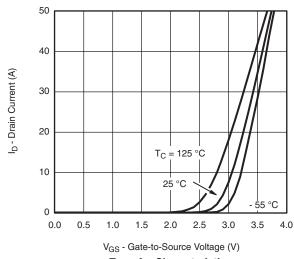
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



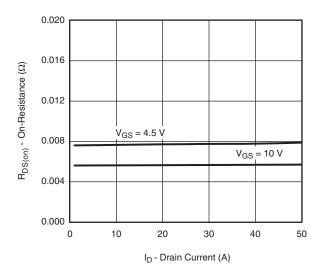


Transfer Characteristics

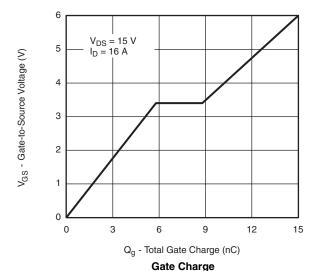




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current



I_S - Source Current (A) T_J = 150 °C 10 T_J = 25 °C

0.4

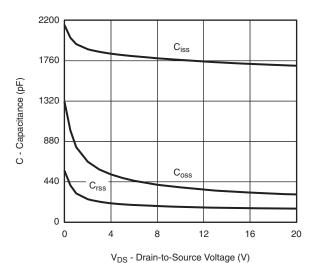
 V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage

0.6

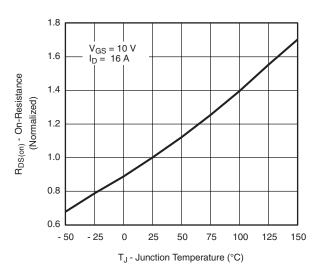
0.8

1.0

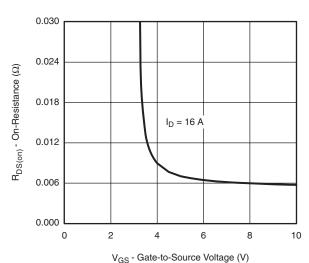
1.2



Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

0.00

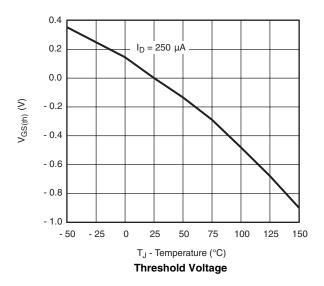
0.2

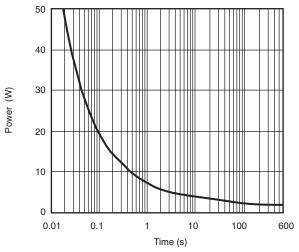
60

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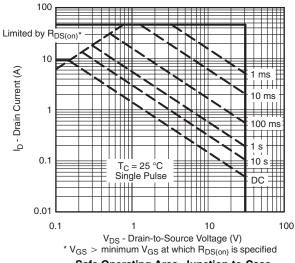
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

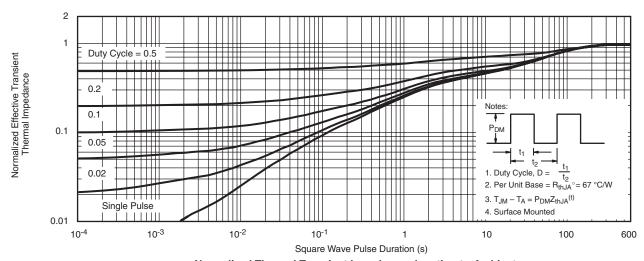




Single Pulse Power



Safe Operating Area, Junction-to-Case

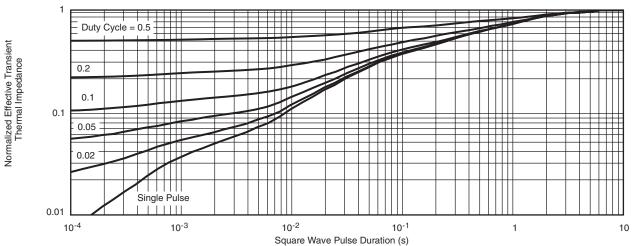


Normalized Thermal Transient Impedance, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



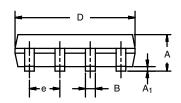
Normalized Thermal Transient Impedance, Junction-to-Foot

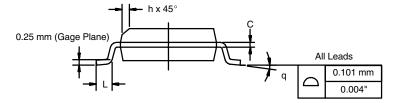
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	MILLIMETERS INCHES				
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	50 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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